## ePIC SVT WP3 Electrical Interfaces Meeting

**December 12, 2024**



# ePIC SVT daisy chain SpTAB structure: proposal on possible realization

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# Outline



- Initial data/idea
- Proposal on possible realization
- Questions
- Next steps/plan
- Conclusions


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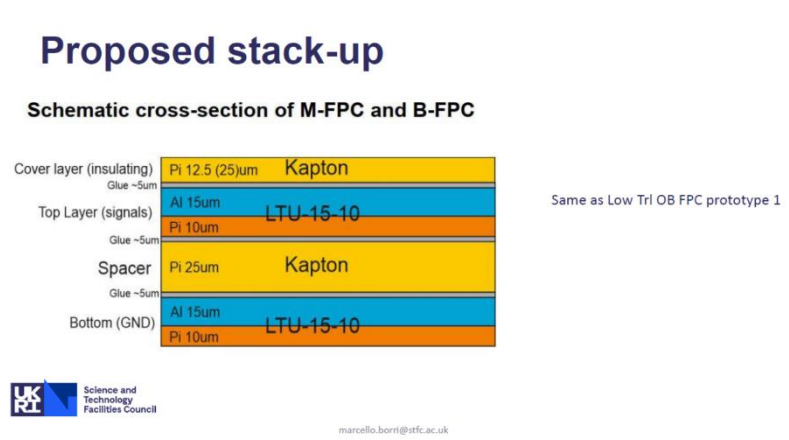
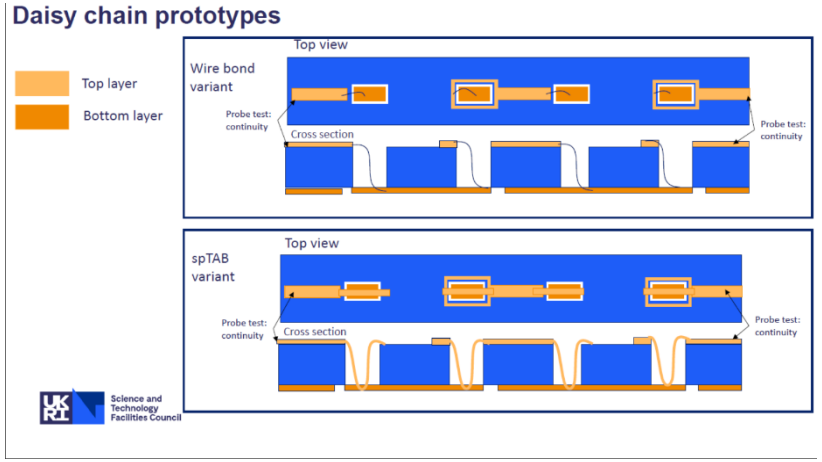
# Initial data/idea

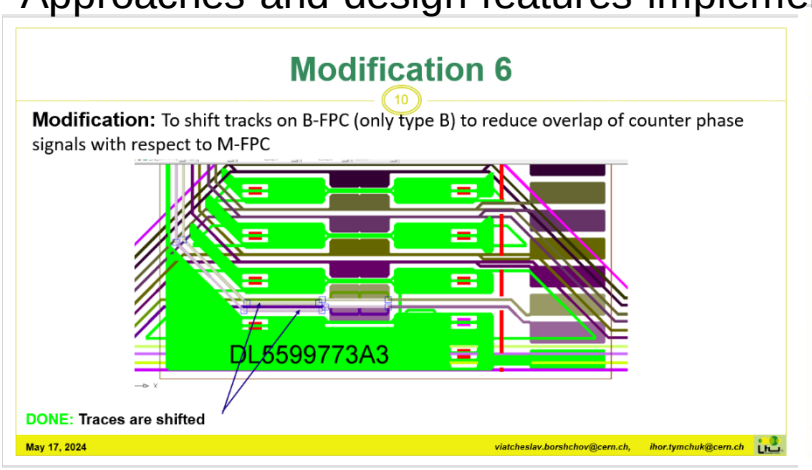


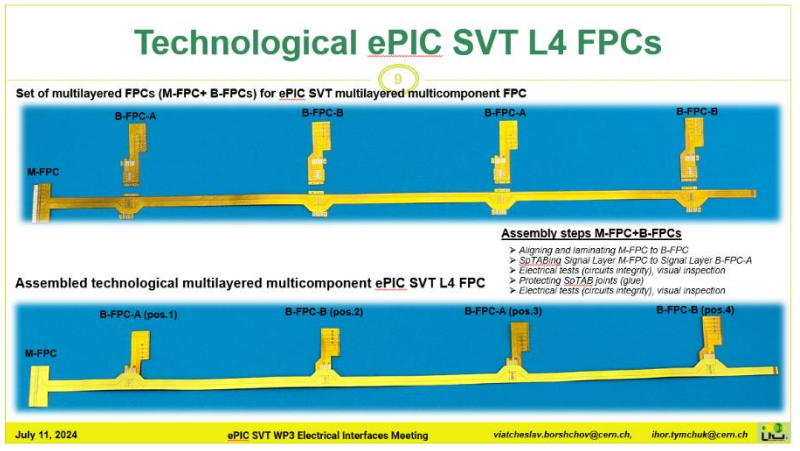
Marcello's slides

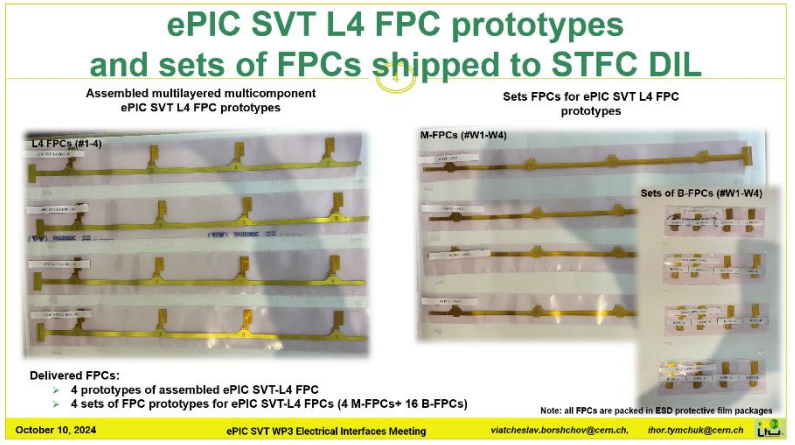



Approaches and design features implemented in ePIC STV L4 FPC

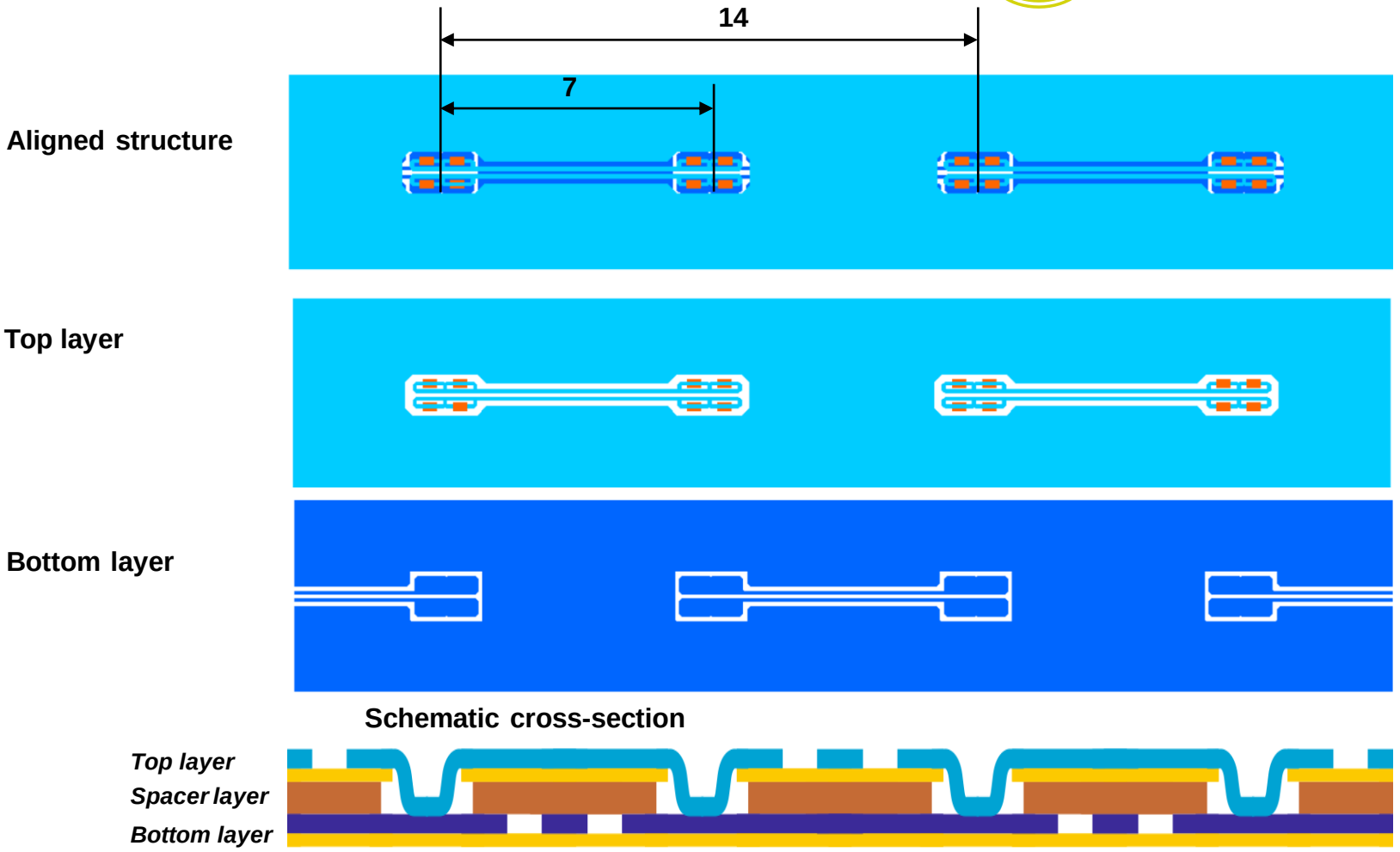


# Possible realization of SpTAB ePIC SVT daisy chain structure (DChSt)






**Some design features:**

- Structure same as for ePIC SVT L4 FPC
- SpTAB area same as for ePIC SVT L4 FPC
- Width of traces in bond area ~70um
- Pitch of bond areas in one structure -7mm
- Pitch of structures -14mm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# Questions



- Are contact pads on top layer needed only on ends of daisy chain structure of also intermediate pads are needed?
- Ni layer on contact pads? Is it necessary? Bare aluminium?
- Preferable dimensions of the contact pads for probes?
- Which types of the structure need to be provided? Assembled (SpTABed + protected) or unassembled (not SpTABed)?
- Which parameters on the Daisy chain structures will be measured/tested?


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# Next steps/plan



- Finalizing design
- Sending for final consideration, agreeing
- Designing photomasks
- Manufacturing SpTAB daisy chain structures


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# Conclusions



- SpTAB daisy chain structure preliminary design developed and proposed
- Daisy chain structure realized similar to ePIC SVT L4 FPC in bond areas
- Next steps are defined and proposed


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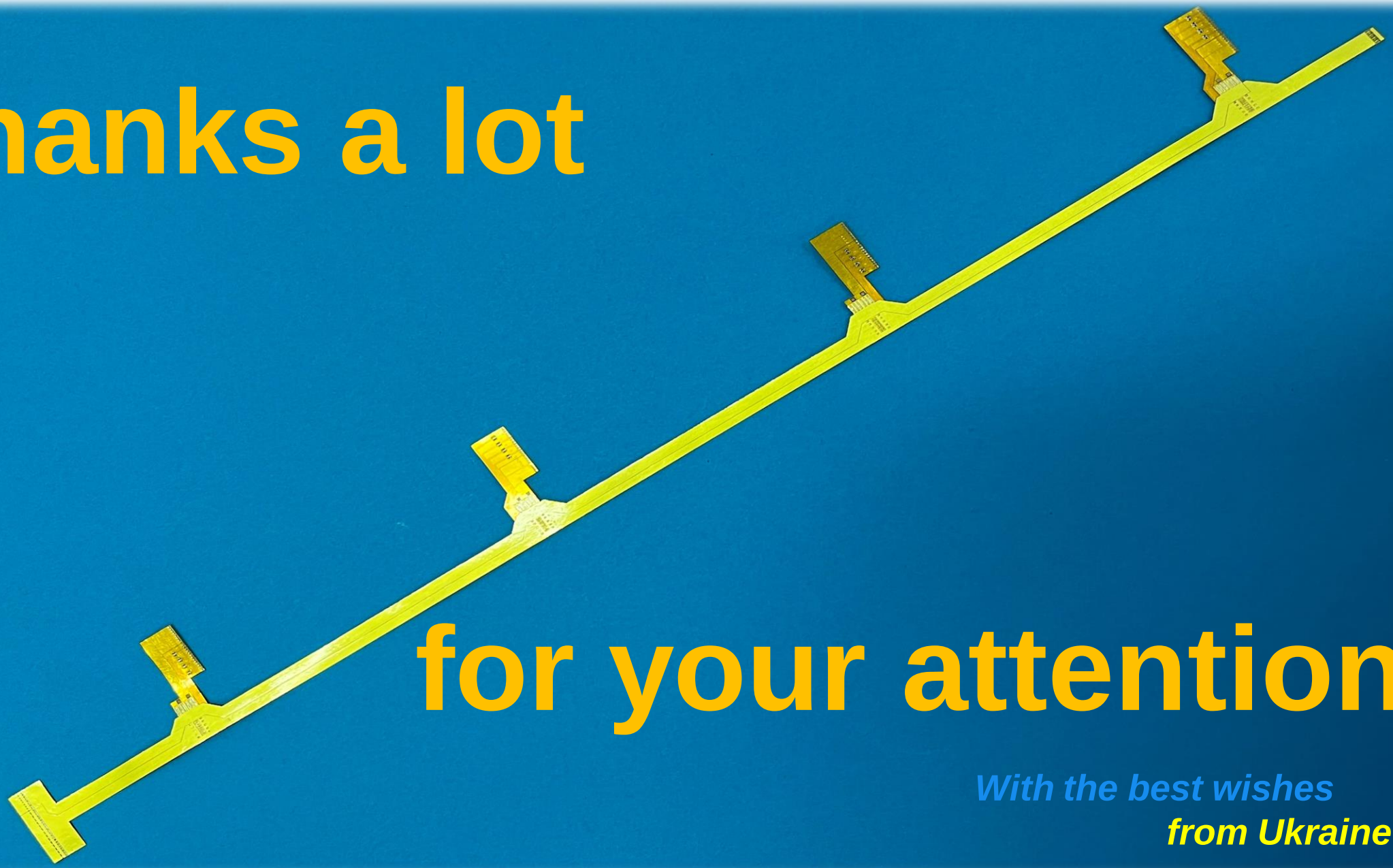
# Thanks a lot



# for your attention!

*With the best wishes*
*from Ukraine!*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